74LV393

Dual 4-bit binary ripple counter

Rev. 6 — 19 March 2021

Product data sheet

1. General description

The 74LV393 is a dual 4-stage binary ripple counter. Each counter features a clock input ($n\overline{CP}$), an overriding asynchronous master reset input (nMR) and 4 buffered parallel outputs (nQ0 to nQ3). The counter advances on the HIGH-to-LOW transition of $n\overline{CP}$. A HIGH on nMR clears the counter stages and forces the outputs LOW, independent of the state of $n\overline{CP}$. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess V_{CC} .

2. Features and benefits

- Optimized for low voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) 0.8 V at V_{CC} = 3.3 V, T_{amb} = 25 °C
- Typical V_{OHV} (output V_{OH} undershoot) 2 V at V_{CC} = 3.3 V, T_{amb} = 25 °C
- · Two 4-bit binary counters with individual clocks
- Divide-by any binary module up to 28 in one package
- Two master resets to clear each 4-bit counter individually
- · Complies with JEDEC standard no. 7A
- · ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V

3. Ordering information

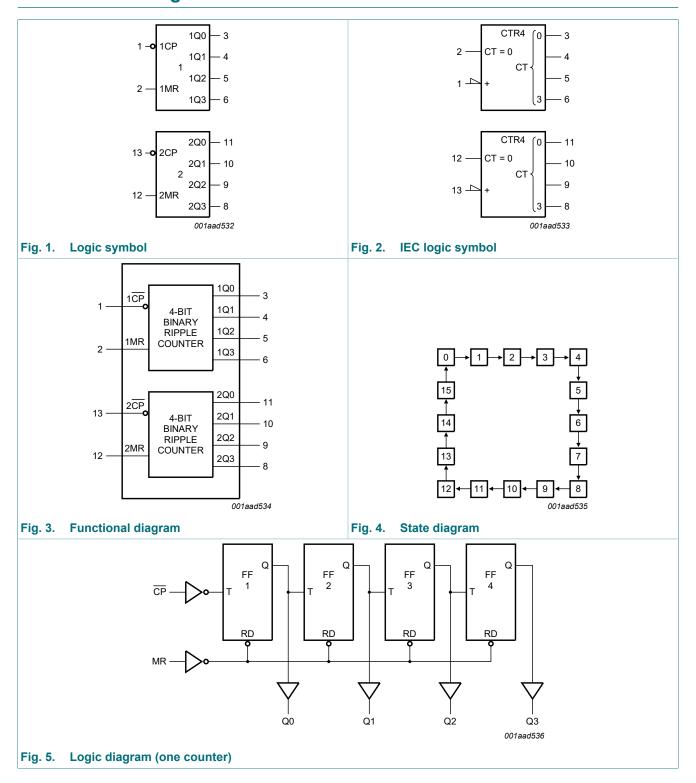
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LV393D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74LV393PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1



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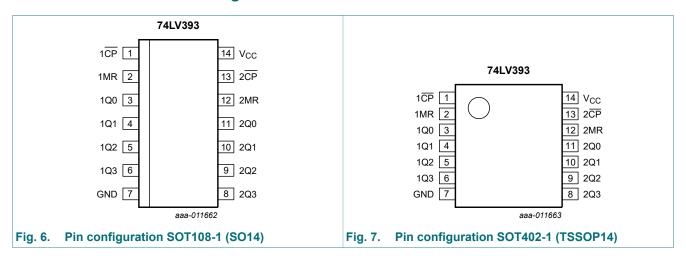
4. Functional diagram



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5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP, 2CP	1, 13	clock input (HIGH-to-LOW, edge-triggered)
1MR, 2MR	2, 12	asynchronous master reset input (active HIGH)
1Q0, 1Q1, 1Q2, 1Q3	3, 4, 5, 6	flip-flop output
GND	7	ground (0 V)
2Q0, 2Q1, 2Q2, 2Q3	11, 10, 9, 8	flip-flop output
V _{CC}	14	supply voltage

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6. Functional description

Table 3. Count sequence for one counter

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level.$

Count	Output			
	nQ0	nQ1	nQ2	nQ3
0	L	L	L	L
1	Н	L	L	L
2	L	Н	L	L
3	Н	Н	L	L
4	L	L	Н	L
5	Н	L	Н	L
6	L	Н	Н	L
7	Н	Н	Н	L
8	L	L	L	Н
9	Н	L	L	Н
10	L	Н	L	Н
11	Н	Н	L	Н
12	L	L	Н	Н
13	Н	L	Н	Н
14	L	Н	Н	Н
15	Н	Н	Н	Н

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	ı	Vlin	Max	Unit
V_{CC}	supply voltage		-	0.5	+4.6	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _{OK}	output clamping current	V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V		-	±50	mA
Io	output current	$V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	+50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[1]	-	500	mW

^[1] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C. For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.0	3.3	3.6	V
VI	input voltage		0	-	V_{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.0 V to 2.0 V	-	-	500	ns/V
		V _{CC} = 2.0 V to 2.7 V	-	-	200	ns/V
		V _{CC} = 2.7 V to 3.6 V	-	-	100	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	°C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level input	V _{CC} = 1.2 V	0.9	-	-	0.9	-	V
	voltage	V _{CC} = 2.0 V	1.4	-	-	1.4	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V_{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.3	-	0.3	V
	voltage	V _{CC} = 2.0 V	-	-	0.6	-	0.6	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V_{OH}	HIGH-level output	$V_I = V_{IH}$ or V_{IL}						•
	voltage	I _O = -100 μA; V _{CC} = 1.2 V	-	1.2	-	-	-	V
		I _O = -100 μA; V _{CC} = 2.0 V	1.8	2.0	-	1.8	-	V
		I_{O} = -100 μ A; V_{CC} = 2.7 V	2.5	2.7	-	2.5	-	V
		I _O = -100 μA; V _{CC} = 3.0 V	2.80	3.0	-	2.8	-	V
		I_{O} = -6 mA; V_{CC} = 3.0 V	2.40	2.82	-	2.20	-	V
V_{OL}	LOW-level output	$V_I = V_{IH}$ or V_{IL}						
	voltage	I _O = 100 μA; V _{CC} = 1.2 V	-	0	-	-	-	V
		I _O = 100 μA; V _{CC} = 2.0 V	-	0	0.2	-	0.2	V
		I _O = 100 μA; V _{CC} = 2.7 V	-	0	0.2	-	0.2	V
		I _O = 100 μA; V _{CC} = 3.0 V	-	0	0.2	-	0.2	V
		I _O = 6 mA; V _{CC} = 3.0 V	-	0.25	0.40	-	0.50	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$	-	-	1.0	-	1.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6 \text{ V}$	-	-	20.0	-	160	μΑ
Δl _{CC}	additional supply current	per input; V _I = V _{CC} - 0.6 V; V _{CC} = 2.7 V to 3.6 V	-	-	500	-	850	μΑ
Cı	input capacitance		-	3.5	-	-	-	pF

^[1] All typical values are measured at T_{amb} = 25 °C.

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10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation	nCP to nQ0; see Fig. 8	[2]						
	delay	V _{CC} = 1.2 V		-	75	-	-	-	ns
		V _{CC} = 2.0 V		-	26	49	-	60	ns
		V _{CC} = 2.7 V		-	19	36	-	44	ns
		$V_{CC} = 3.3 \text{ V}, C_L = 15 \text{ pF}$		-	12	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	14	29	-	35	ns
		nQ to nQn+1; see Fig. 8	[2]						
		V _{CC} = 1.2 V		-	25	-	-	-	ns
		V _{CC} = 2.0 V		-	9	17	-	20	ns
		V _{CC} = 2.7 V		-	6	13	-	15	ns
		$V_{CC} = 3.3 \text{ V}, C_L = 15 \text{ pF}$		-	4	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	5	10	-	12	ns
t _{PHL}	HIGH to LOW	nMR to nQx; see Fig. 9							
	propagation delay	V _{CC} = 1.2 V		-	70	-	-	-	ns
	delay	V _{CC} = 2.0 V		-	24	44	-	54	ns
		V _{CC} = 2.7 V		-	18	33	-	40	ns
		V_{CC} = 3.3 V, C_L = 15 pF		-	11	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	13	26	-	32	ns
t _W	pulse width	nCP HIGH or LOW; see Fig. 8							
		V _{CC} = 2.0 V		34	10	-	41	-	ns
		V _{CC} = 2.7 V		25	8	-	30	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	20	6	-	24	-	ns
		nMR HIGH; see Fig. 9							
		V _{CC} = 2.0 V		34	12	-	41	-	ns
		V _{CC} = 2.7 V		25	9	-	30	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	20	7	-	24	-	ns
t _{rec}	recovery time	nMR to nCP; see Fig. 9							
		V _{CC} = 1.2 V		-	5	-	-	-	ns
		V _{CC} = 2.0 V		5	2	-	5	-	ns
		V _{CC} = 2.7 V		5	2	-	5	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	5	1	-	5	-	ns
f _{max}	maximum	see Fig. 8					•		,
	frequency	V _{CC} = 2.0 V		14	53	-	12	-	MHz
		V _{CC} = 2.7 V		19	72	-	16	-	MHz
		$V_{CC} = 3.3 \text{ V, } C_L = 15 \text{ pF}$		-	99	-	-	-	MHz
		V _{CC} = 3.0 V to 3.6 V	[3]	24	90	-	20	-	MHz

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Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to	Unit		
				Min	Typ[1]	Max	Min	Max	
C _{PD}	power dissipation capacitance	V _I = GND to V _{CC}	[3] [4]	-	23	-	-	-	pF

- All typical values are measured at T_{amb} = 25 °C.
- t_{pd} is the same as t_{PLH} and t_{PHL} . Typical values are measured at V_{CC} = 3.3 V.
- C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

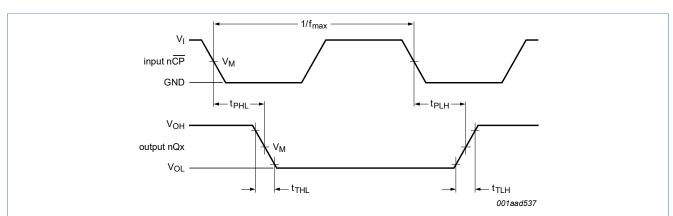
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

10.1. Waveforms and test circuit



 $t_{TLH} = 10 \%$ and $t_{THL} = 90 \%$,

Measurement points are given in Table 8.

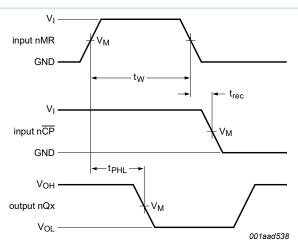
V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 8. Propagation delays clock (nCP) to output (nQx), output transition times and maximum clock frequency

Table 8. Measurement points

Supply voltage V _{CC}	Input	Output						
	V _M	V _M	V _X	V _Y				
< 2.7 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.1V _{CC}	V _{OH} - 0.1V _{CC}				
2.7 V to 3.6 V	1.5V _{CC}	1.5V _{CC}	$V_{OL} + 0.3V_{CC}$	V _{OH} - 0.3V _{CC}				

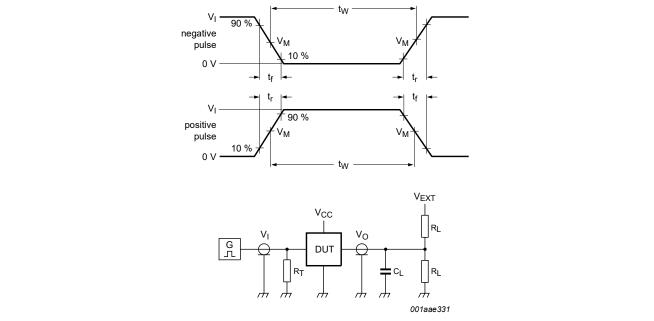
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Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 9. Propagation delays clock (nCP) to output (nQx), pulse width master reset (nMR), and recovery time master reset (nMR) to clock (nCP)



Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 \mathbf{C}_{L} = Load capacitance including jig and probe capacitance.

 R_L = Load resistance.

S1 = Test selection switch.

Fig. 10. Test circuit for measuring switching times

Table 9. Test data

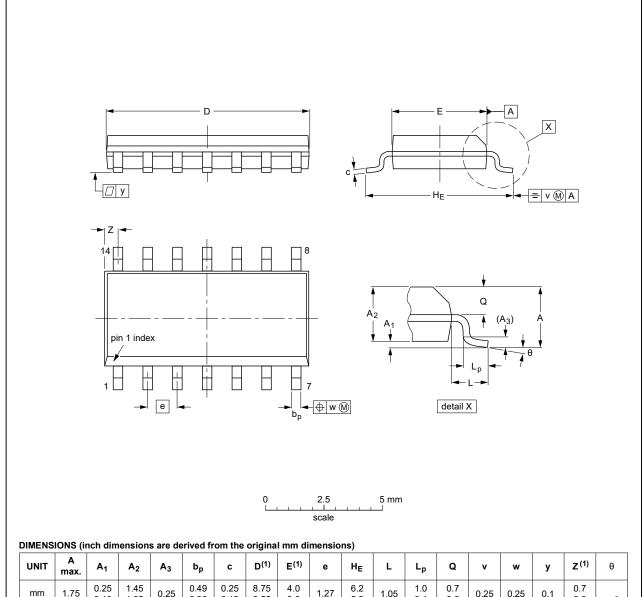
Supply voltage	Input		Load	V _{EXT}	
V _{CC}	V _I	t _r , t _f	CL	R _L	t _{PHL} , t _{PLH}
< 2.7 V	V _{CC}	≤ 2.5 ns	50 pF	1 kΩ	open
2.7 V to 3.6 V	2.7 V	≤ 2.5 ns	15 pF, 50 pF	1 kΩ	open

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11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
i	nches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

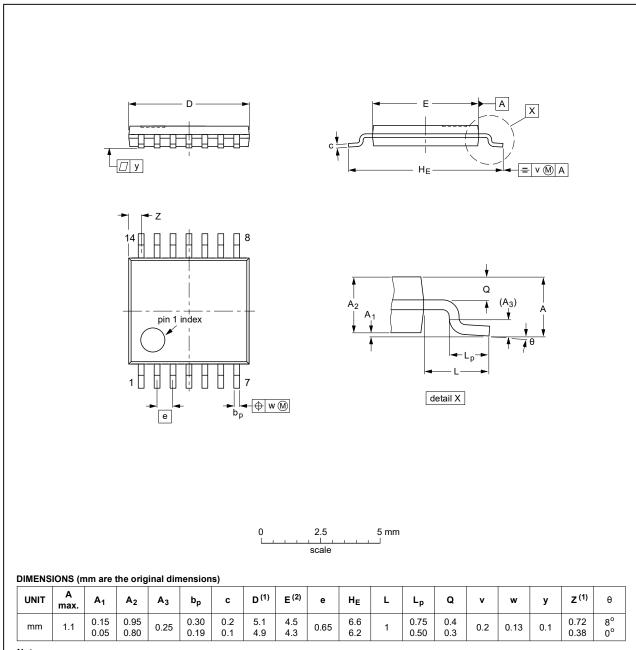
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			99-12-27 03-02-19

Fig. 11. Package outline SOT108-1 (SO14)

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT402-1		MO-153				99-12-27 03-02-18

Fig. 12. Package outline SOT402-1 (TSSOP14)

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12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LV393 v.6	20210319	Product data sheet	-	74LV393 v.5
Modifications:	The format of of Nexperia.	f this data sheet has been rec	lesigned to comply wi	th the identity guidelines
		ave been adapted to the new	company name wher	e appropriate.
	<u>Section 1</u> upo			
		erating values for P _{tot} total pov		ed.
	 Type number 	74LV393DB (SOT337-1 / SS	SOP14) removed.	
74LV393 v.5	20151208	Product data sheet	-	74LV393 v.4
Modifications:	Type number	74LV393N (SOT27-1) remov	red.	
74LV393 v.4	20140918	Product data sheet	-	74LV393 v.3
Modifications:	<u>Table 4</u> minus	s sign added to the minimum	ground current.	'
	• <u>Fig. 10</u> and <u>T</u>	able 9 updated because of a	missing load resistan	ce in the test circuit.
74LV393 v.3	20140428	Product data sheet	-	74LV393 v.2
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 			
74LV393 v.2	19970610	Product specification	-	74LV393 v.1
74LV393 v.1	19970304	Product specification	-	-

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14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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